

# Thermoelectric properties of $\text{Bi}_2\text{Te}_3$ and $\text{Sb}_2\text{Te}_3$ and its bilayer thin films

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The  $\text{Bi}_2\text{Te}_3$ ,  $\text{Sb}_2\text{Te}_3$  and  $\text{Bi}_2\text{Te}_3$ - $\text{Sb}_2\text{Te}_3$  bilayer thin films of various thickness have been prepared using thermal evaporation at vacuum. X-ray diffraction method is used for the characterisation of the samples. Electrical studies have been carried out using the standard four probe method and then the activation energies of each film before and after annealing are obtained. Thermoelectric behaviour of each sample is also determined at various temperature regions.

**Keywords:** Thin films, Thermoelectric properties, Bilayer thin films

## 1 Introduction

The thermoelectric effect is the appearance of an electric field along a temperature gradient established in a material. The materials which convert heat flow into electrical current and vice versa are known as thermoelectric materials.  $\text{Sb}_2\text{Te}_3$  and  $\text{Bi}_2\text{Te}_3$  are good conventional thermoelectric materials.

These materials have the potential to act as thermoelectric devices, that directly interconvert the energy between the heat and electricity<sup>1,2,3,4,5,6</sup>. The performance of thermoelectric materials and devices is quantified by a dimensionless quantity called figure of merit  $Z$ , which is defined as  $Z = \alpha^2 \sigma / k$ , where  $\alpha$  is the seebeck coefficient,  $\sigma$  is the electrical conductivity and  $k$  is the thermal conductivity.  $Z$  can be increased by increasing  $\alpha$  and  $\sigma$  or decreasing  $k$ . Among these properties, the reduction of thermal conductivity is thought to be the most effective approach to improve the thermoelectric performance. Though all known new electric materials are believed to have  $Z \leq 1$ , theoretical results of Hicks *et al.*<sup>7</sup> predict that thermoelectric devices fabricated as 2-D quantum well, or 1-D quantum wires could have  $Z \geq 3$ . A good thermoelectric material should have large seebeck coefficient ( $\alpha$ ) to produce the required voltage, low thermal conductivity ( $k$ ) to keep the heat at the junction and low electrical resistivity ( $\rho$ ) to minimize Joule heating<sup>8</sup>.  $\text{V}_2\text{VI}_3$  binary compounds such as  $\text{Sb}_2\text{Te}_3$  and  $\text{Bi}_2\text{Te}_3$  are narrow band-gap semi-conductors with the homologous layered crystal structure.  $\text{Sb}_2\text{Te}_3$  and  $\text{Bi}_2\text{Te}_3$  are semi-metal alloys, and have good electrical conductivity and low thermal conductivity<sup>9,10</sup>. They can be used for many different applications which typically fall into two general

categories, power generation and cooling devices<sup>11</sup>. Thermoelectric power generators and coolers have many advantages over conventional refrigerators and power generators such as long life, no moving parts, no green house gases, no noise, low maintenance and high reliability<sup>12,13</sup>.  $\text{Bi}_2\text{Te}_3$  is reported as N type and  $\text{Sb}_2\text{Te}_3$  is reported as P type semiconductors. But the presence of excess tellurium may change the type. Both of them have high thermoelectric power compared to other semiconductors. They have high electrical conductivity than pure semiconductors and have low thermal conductivity. In order to improve thermoelectric properties,  $\text{Sb}_2\text{Te}_3$  and  $\text{Bi}_2\text{Te}_3$  can be annealed<sup>14</sup>. For efficient devices multiple layers of  $\text{Bi}_2\text{Te}_3$  and  $\text{Sb}_2\text{Te}_3$  are necessary.

In this paper, the thermoelectric properties of  $\text{Bi}_2\text{Te}_3$ ,  $\text{Sb}_2\text{Te}_3$  and its bilayer thin films prepared by evaporating solid antimony telluride and bismuth telluride have been studied.

## 2 Experimental Details

### 2.1 Thin film fabrication

All the three samples,  $\text{Bi}_2\text{Te}_3$ ,  $\text{Sb}_2\text{Te}_3$  and  $\text{Bi}_2\text{Te}_3$ - $\text{Sb}_2\text{Te}_3$  bilayer films are prepared by the vacuum thermal evaporation method. Deposition is done over the glass substrates. To clean the substrates, they are first washed and put in acetone and placed in ultrasonic agitator for half an hour. Substrates are taken from the acetone and dried in hot air using a heater. An oil diffusion pump backed by a rotary pump is used for attaining vacuum of the order of  $10^{-6}$  torr. Pure antimony telluride and bismuth telluride powder are separately evaporated under a vacuum of the order of  $10^{-6}$  torr for fabricating single layer

$\text{Sb}_2\text{Te}_3$  and  $\text{Bi}_2\text{Te}_3$  thin films of thickness 1500 and 1000 Å, respectively. To prepare the bilayer film,  $\text{Sb}_2\text{Te}_3$  is deposited on a predeposited  $\text{Bi}_2\text{Te}_3$  film of thickness 1000 Å, up to a total thickness of 2000 Å. After several repetitions good quality thin films with high adhesion and surface features were obtained.

## 2.2 Film characterisation

To identify the structure of the film, X-ray diffraction method is used. X-ray diffraction pattern of  $\text{Sb}_2\text{Te}_3$  shows three well defined peaks which imply its crystalline structure. Also in the case of  $\text{Bi}_2\text{Te}_3$  film and the bilayer film, the X-ray diffraction analysis reveals the polycrystalline structure.  $\text{Sb}_2\text{Te}_3$  possesses a rhombohedral structure same as that of  $\text{Bi}_2\text{Te}_3$ . Figure 1 shows XRD pattern of annealed and unannealed  $\text{Sb}_2\text{Te}_3$  thin films. It shows three well defined peaks at the  $2\theta$  values of about 25, 30, and 40 degrees respectively. Figures 2 and 3 show the XRD patterns of unannealed and annealed  $\text{Bi}_2\text{Te}_3$  thin films. Both have peaks at the  $2\theta$  values about 17, 24 and 27 degrees. Figures 4 and 5 are the X-ray diffraction patterns of unannealed and annealed  $\text{Bi}_2\text{Te}_3$ - $\text{Sb}_2\text{Te}_3$  respectively which have peaks at 28, 40, 42.5, 43.5 and 49.7 degrees.

The particle sizes have been calculated using the Scherrer formula. The average particle sizes for  $\text{Sb}_2\text{Te}_3$  are 5.545 Å and 4.666 Å for annealed and

unannealed samples, respectively. For  $\text{Bi}_2\text{Te}_3$ , it is found as 27 Å and 22.8 Å for annealed and unannealed, respectively. In the case of bilayer film, for the unannealed sample, the average particle size is 21.36 Å and for the annealed sample, it is found as 23.40 Å.

## 2.3 Electrical properties

The *dc* conductivity study is one the important study to find the behaviour of thin film materials. Conductivity studies of each sample are carried out

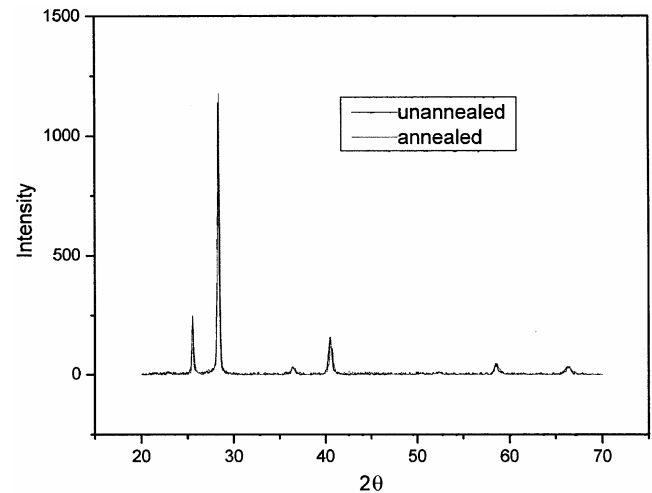


Fig. 1 — X-ray diffraction pattern of  $\text{Sb}_2\text{Te}_3$  thin film

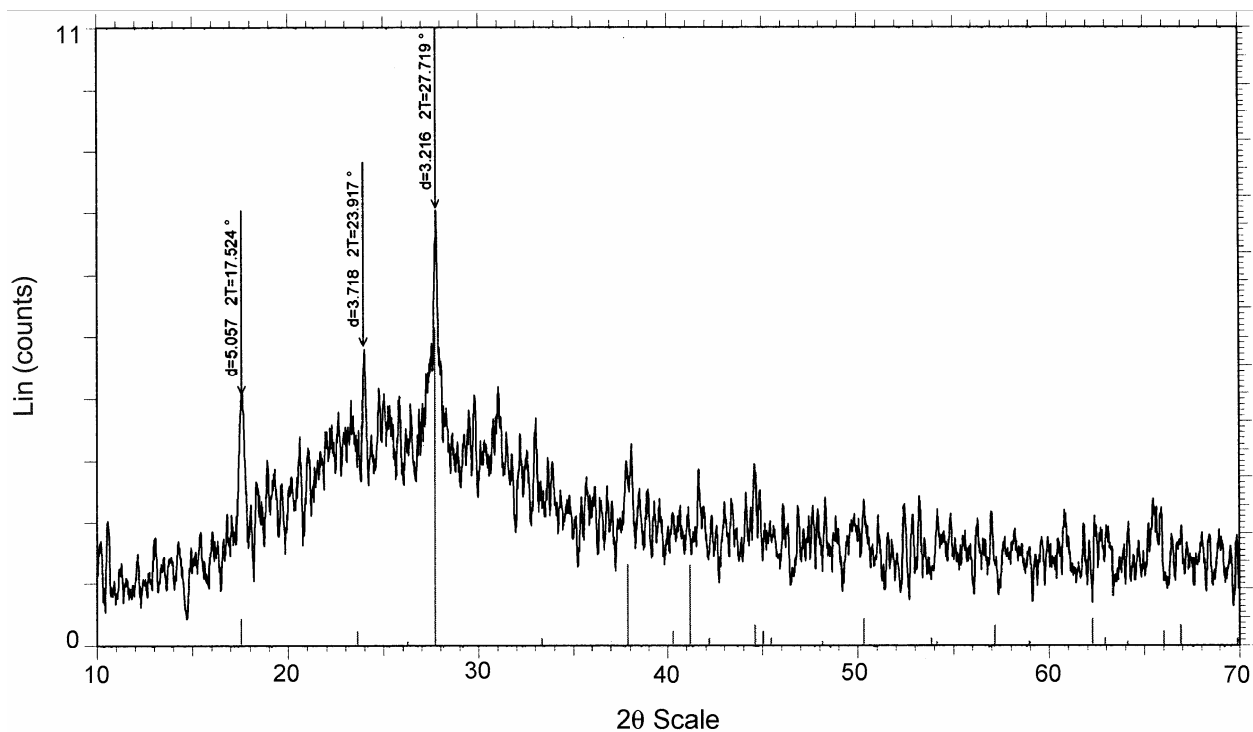
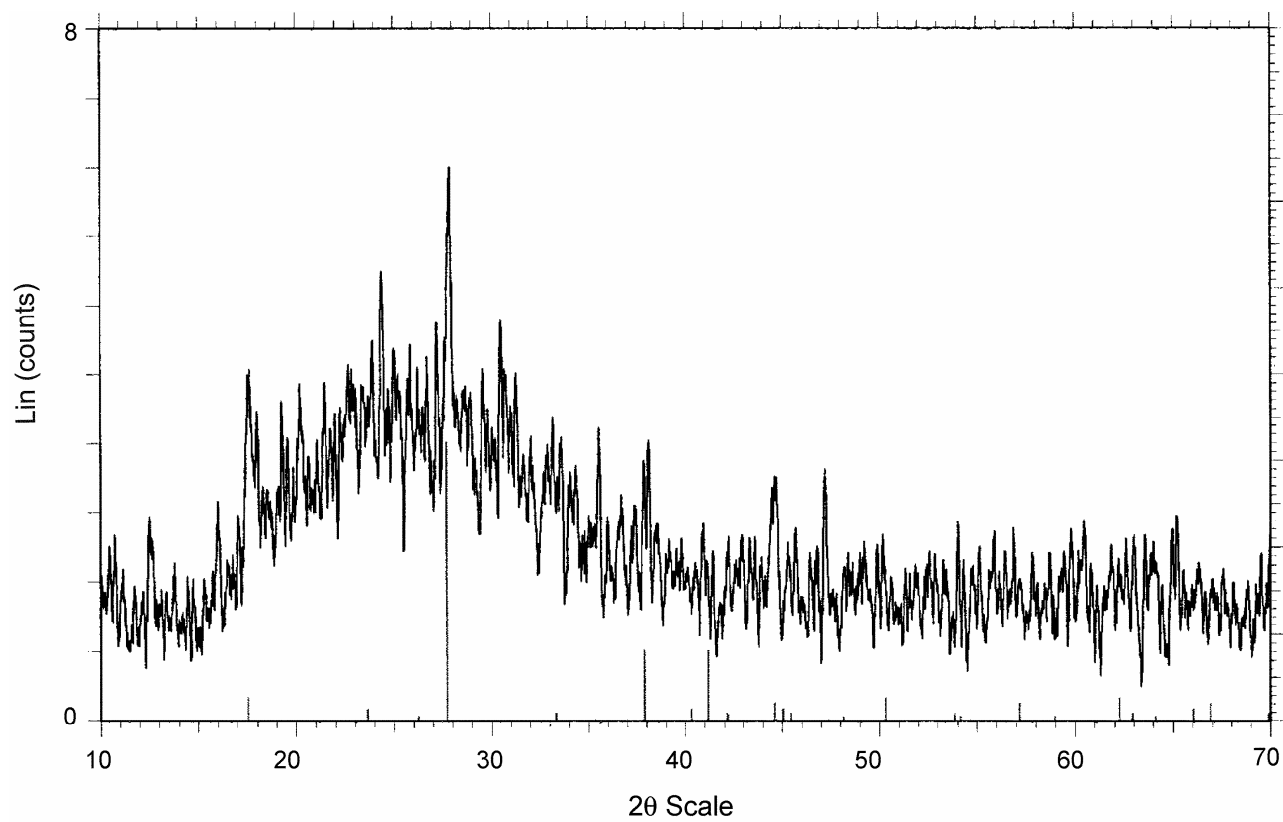
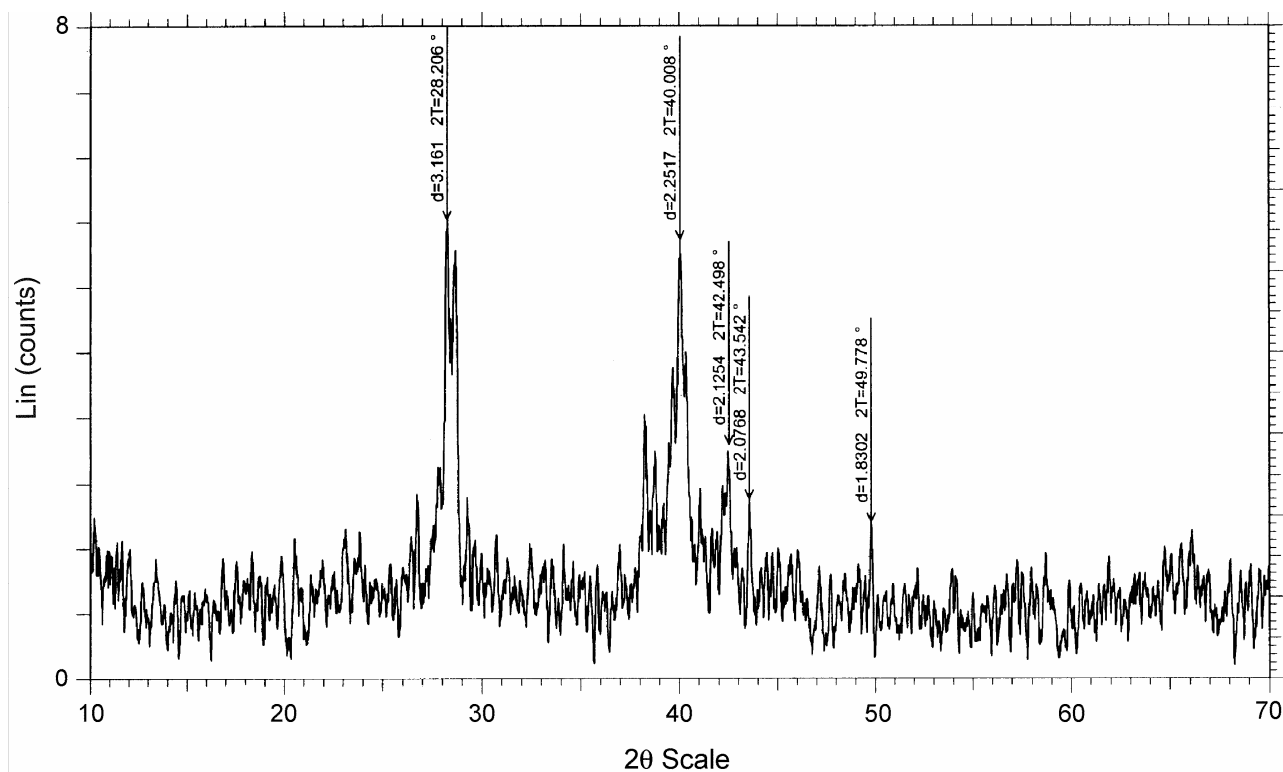


Fig. 2 — X-ray diffraction pattern of  $\text{Bi}_2\text{Te}_3$  thin film

Fig. 3 — X-ray diffraction pattern of annealed  $\text{Bi}_2\text{Te}_3$  thin filmFig. 4 — X-ray diffraction pattern of  $\text{Bi}_2\text{Te}_3$  -  $\text{Sb}_2\text{Te}_3$  bilayer film

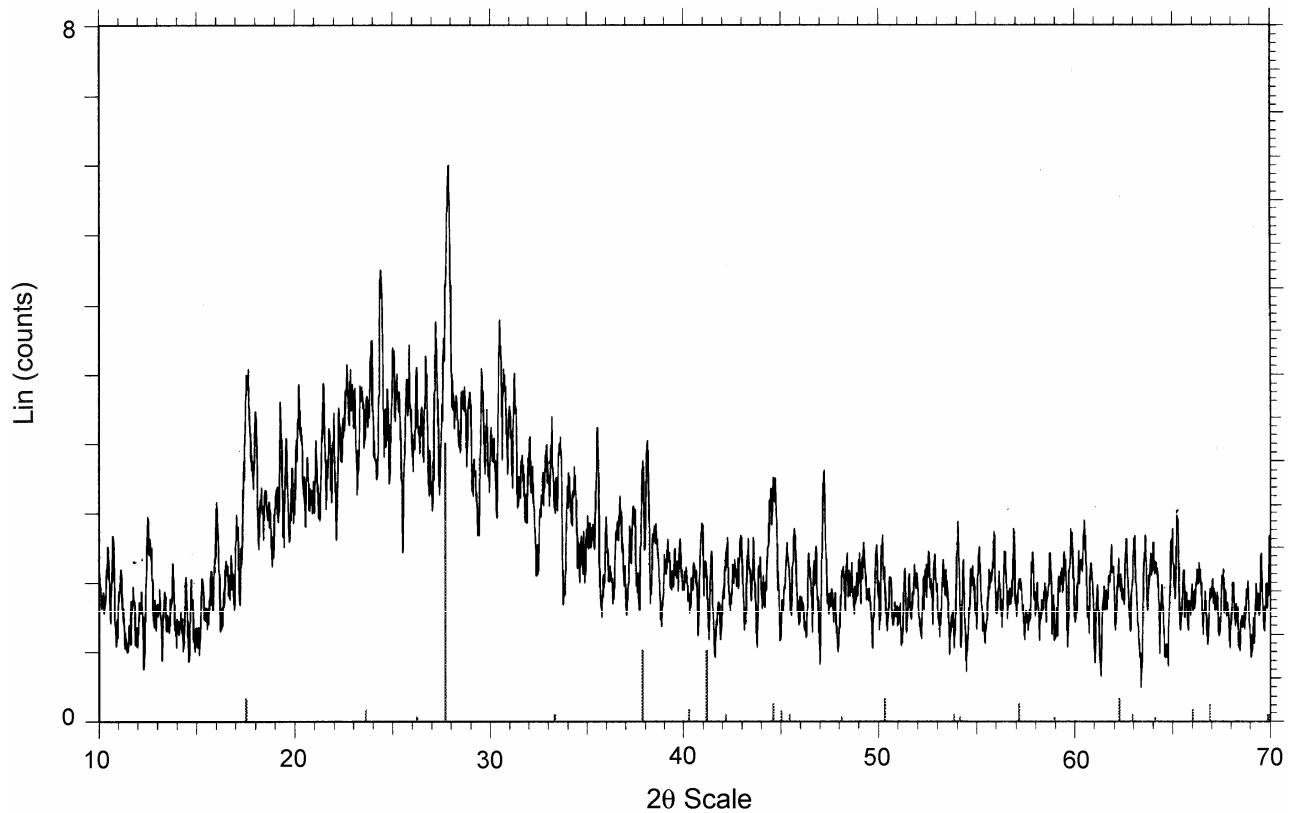


Fig. 5 — X-ray diffraction pattern of annealed  $\text{Bi}_2\text{Te}_3 - \text{Sb}_2\text{Te}_3$  bilayer film

using standard four probe technique. Keeping the current as a constant, the voltage is measured for different temperature varying from 30 to  $150^\circ\text{C}$ . For each case, a graph is plotted between the inverse of temperature and log of sheet resistivity. Figures 6-8 explain the variation of sheet resistivity of  $\text{Sb}_2\text{Te}_3$ ,  $\text{Bi}_2\text{Te}_3$  and  $\text{Bi}_2\text{Te}_3\text{-Sb}_2\text{Te}_3$  bilayer thin films respectively before and after annealing.

As the temperature increases, sheet resistivity decreases for unannealed  $\text{Sb}_2\text{Te}_3$  film and increases for annealed  $\text{Sb}_2\text{Te}_3$  film. From the graph, it is clear that the sheet resistivity decreases or conductivity increases with increase in temperature for unannealed  $\text{Sb}_2\text{Te}_3$  which explains its semiconducting behaviour while annealed  $\text{Sb}_2\text{Te}_3$  exhibits conducting behaviour, since its resistivity increases with increase in temperature. The activation energies are found as 0.007 and 0.0286 eV for the unannealed and annealed samples, respectively. In the case of  $\text{Bi}_2\text{Te}_3$ , both unannealed and annealed samples show semiconducting behaviour. The activation energies are found as 0.005 and 0.016 eV respectively. In the case of the bilayer film, the unannealed sample shows, semiconducting behaviour with an activation energy of 0.054 eV while the annealed sample shows

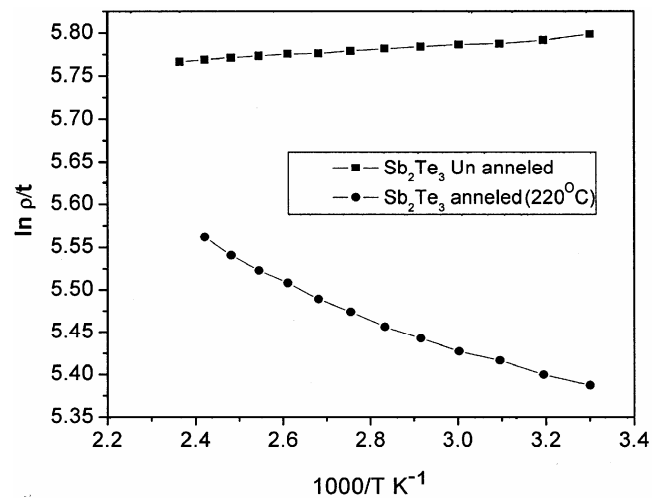


Fig. 6 — Sheet resistivity of unannealed and annealed  $\text{Sb}_2\text{Te}_3$  thin film as a function of inverse of temperature

conducting behaviour with an activation energy of 0.046 eV.

#### 2.4 Thermoelectric properties

The thermoelectric power (Seebeck coeff  $\alpha$ ) of each sample are calculated. For this measurement, the sample is arranged in such a way that one end is at the

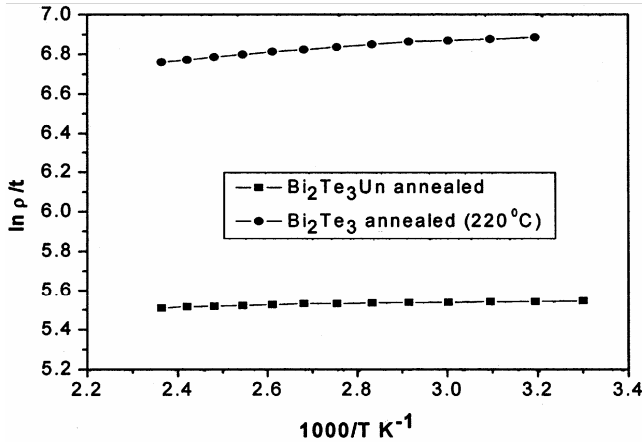


Fig. 7 — Sheet resistivity of unannealed and annealed  $\text{Bi}_2\text{Te}_3$  thin film as a function of inverse of temperature

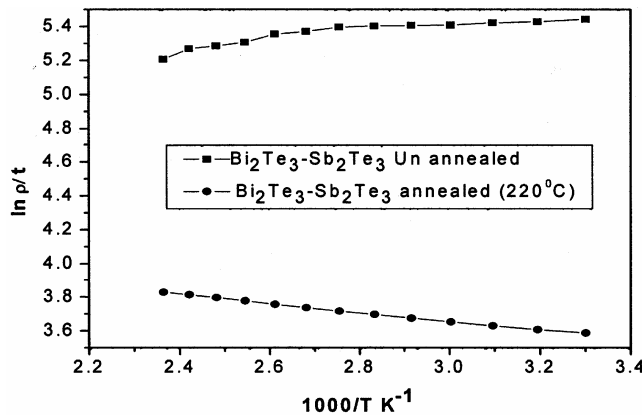


Fig. 8 — Sheet resistivity of  $\text{Bi}_2\text{Te}_3 - \text{Sb}_2\text{Te}_3$  bilayer thin film as a function of inverse of temperature

hot junction and the other is at the cold junction. The temperature of the hot junction is varied successively. The thermoemf are noted for each value of hot junction temperature. From the thermo emf versus  $dT$  (difference between the temperature of two junctions) graph, the slope is determined which gives the thermo electric power (TEP) or the seebeck coefficient. For each sample, TEP versus  $T_h$  (hot junction temperature) is also plotted.

Figure 9 explains the variation of thermoelectric power of  $\text{Sb}_2\text{Te}_3$ ,  $\text{Bi}_2\text{Te}_3$  and  $\text{Bi}_2\text{Te}_3\text{-Sb}_2\text{Te}_3$  bilayer thin films respectively at various temperature regions.

The figure of merit and the power factor are also calculated for each film. For antimony telluride a figure of merit of 0.17 is obtained. For the  $\text{Bi}_2\text{Te}_3$  film and for the bilayer film, it is found as 0.43 and 0.49 respectively. The power factors are found as  $0.8 \times 10^{-3}$ ,  $1.74 \times 10^{-3}$  and  $2.24 \times 10^{-3} \text{ WK}^{-2}\text{m}^{-1}$  respectively for  $\text{Sb}_2\text{Te}_3$ ,  $\text{Bi}_2\text{Te}_3$  and the bilayer films.

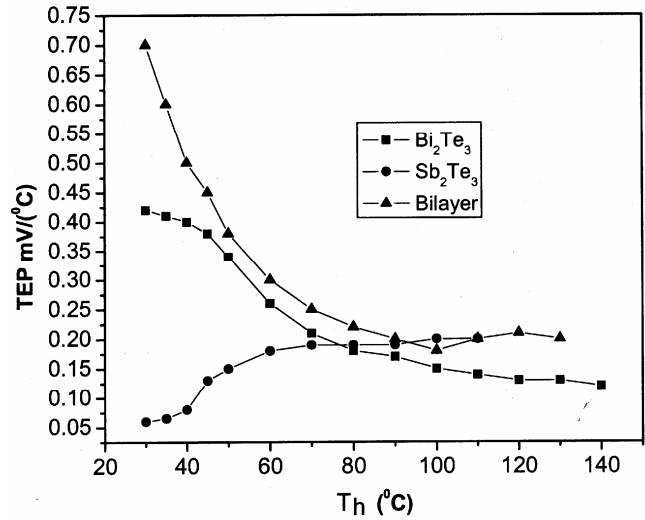


Fig. 9 — Thermo-electric power of  $\text{Sb}_2\text{Te}_3$ ,  $\text{Bi}_2\text{Te}_3$  and  $\text{Bi}_2\text{Te}_3\text{-Sb}_2\text{Te}_3$

### 3 Results and Discussion

$\text{Sb}_2\text{Te}_3$ ,  $\text{Bi}_2\text{Te}_3$  and  $\text{Bi}_2\text{Te}_3\text{-Sb}_2\text{Te}_3$  thin films of various thickness are fabricated using thermal evaporation at vacuum. The X-ray diffraction patterns reveal their crystalline structure. From the conductivity studies it can be seen that the annealed  $\text{Sb}_2\text{Te}_3$ , and annealed bilayer film are showing conducting behaviour while the others are showing semiconducting behaviour. It is also observed that for the two single layer films, the activation energy is found to be increasing when annealed. But in the case of bilayer it is found that the activation energy is decreasing when annealed. This may be due to the diffusion of carriers between the layers. From the thermoelectric property studies, it has been found that the three kinds of thin film materials are of having the figure of merit  $Z \leq 1$ , as expected. Among these three, the bilayer of  $\text{Bi}_2\text{Te}_3$  and  $\text{Sb}_2\text{Te}_3$  is having larger value of figure of merit (0.49) which implies that it has higher thermoelectric performance than the others. This may be due to the change in the fermi surface by the diffusion of carriers between the thin film layers.

### 4 Conclusions

Thin films of tellurium alloys such as  $\text{Sb}_2\text{Te}_3$ ,  $\text{Bi}_2\text{Te}_3$  and their bilayer films are well established thermoelectric materials and are widely employed in thermoelectric generators and coolers. The  $\text{Sb}_2\text{Te}_3$  film shows high thermoelectric behaviour at high temperature region while the  $\text{Bi}_2\text{Te}_3$  film and the bilayer film show high thermoelectric behaviour at room temperature region as well as relatively low

temperature regions. The thermoelectric performance will increase if we use the Bi<sub>2</sub>Te<sub>3</sub>-Sb<sub>2</sub>Te<sub>3</sub> bilayer film instead of their single layer film.

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